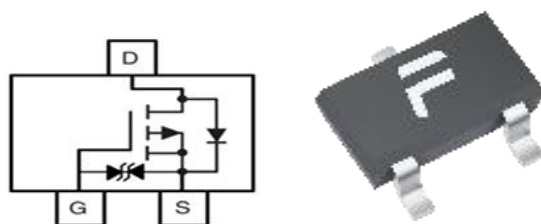


**SOT-523 -20V P Channel Enhancement ESD Protection 沟道增强型带静电保护
MOS Field Effect Transistor 场效应管**



■ **Absolute Maximum Ratings 最大额定值**

Characteristic 特性参数	Symbol 符号	Rat 额定值	Unit 单位
Drain-Source Voltage 漏极-源极电压	BV_{DSS}	-20	V
Gate- Source Voltage 栅极-源极电压	V_{GS}	± 10	V
Drain Current (continuous)漏极电流-连续	I_D (at $T_A = 25^\circ C$)	-0.66	A
Drain Current (pulsed)漏极电流-脉冲	I_{DM}	-1.2	A
Total Device Dissipation 总耗散功率	P_D (at $T_A = 25^\circ C$)	150	mW
Thermal Resistance Junction-Ambient 热阻	$R_{\theta JA}$	835	$^\circ C/W$
ESD Protected Up to 人体模式静电保护范围	ESD(HBM)	2.0	kV
Lead Temperature for Soldering Purposes 管脚焊接温度(1/8" from case for 10 s)	T_L	260	$^\circ C$
Junction/Storage Temperature 结温/储存温度	T_J, T_{stg}	-55~150	$^\circ C$

■ **Device Marking 产品字标**

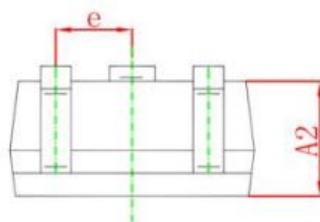
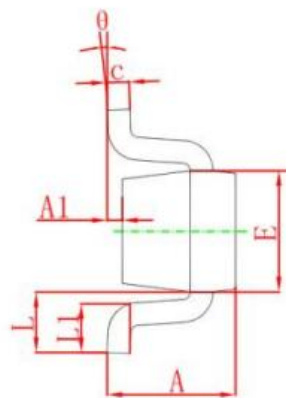
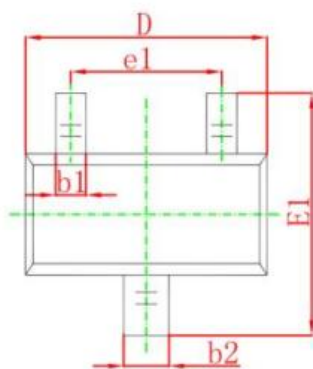
FS3139KT5=39K

Electrical Characteristics 电特性

 (T_A=25°C unless otherwise noted 如无特殊说明, 温度为 25°C)

Characteristic 特性参数	Symbol 符号	Min 最小值	Typ 典型值	Max 最大值	Unit 单位
Drain-Source Breakdown Voltage 漏极-源极击穿电压(I _D = -250uA, V _{GS} =0V)	BV _{DSS}	-20	—	—	V
Gate Threshold Voltage 栅极开启电压(I _D = -250uA, V _{GS} = V _{DS})	V _{GS(th)}	-0.5	-0.7	-0.9	V
Zero Gate Voltage Drain Current 零栅压漏极电流(V _{GS} =0V, V _{DS} = -20V)	I _{DSS}	—	—	-1	μA
Gate Body Leakage 栅极漏电流(V _{GS} =±10V, V _{DS} =0V)	I _{GSS}	—	—	±10	μA
Static Drain-Source On-State Resistance 静态漏源导通电阻(I _D = -0.5A, V _{GS} = -4.5V) (I _D = -0.2A, V _{GS} = -2.5V)	R _{DS(ON)}	—	346 450	400 600	mΩ
Diode Forward Voltage Drop 内附二极管压降(I _{SD} =-0.5A, V _{GS} =0V)	V _{SD}	—	-0.87	-1	V
Input Capacitance 输入电容 (V _{GS} =0V, V _{DS} = -10V, f=1MHz)	C _{ISS}	—	60	—	pF
Common Source Output Capacitance 共源输出电容(V _{GS} =0V, V _{DS} = -10V, f=1MHz)	C _{OSS}	—	14	—	pF
Reverse Transfer Capacitance 反馈电容(V _{GS} =0V, V _{DS} = -10V, f=1MHz)	C _{RSS}	—	8.5	—	pF
Gate Resistance 栅极电阻 (V _{DS} = 0V, V _{GS} =0V, f=1MHz)	R _g	—	170	—	Ω
Forward tranconductance 正向传输导纳 (V _{DS} = -5V, I _D = -500mA)	g _{fs}	—	1.5	—	S
Gate-Source Breakdown Voltage 栅极-源极击穿电压(I _{GS} = ±100uA)	BV _{GSS}	±11	—	±16	V
Turn-ON Delay Time 开启延迟时间 (V _{DS} =-10V I _D =-150mA, R _{GEN} =3 Ω, V _{GS} =-4.5V)	t _{d(on)}	—	7.5	—	ns
Turn-ON Rise Time 开启上升时间 (V _{DS} =-10V I _D =-150mA, R _{GEN} =3 Ω, V _{GS} =-4.5V)	t _r	—	23.3	—	ns
Turn-OFF Delay Time 关断延迟时间 (V _{DS} =-10V I _D =-150mA, R _{GEN} =3 Ω, V _{GS} =-4.5V)	t _{d(off)}	—	39	—	ns
Turn-OFF Fall Time 关断下降时间 (V _{DS} =-10V I _D =-150mA, R _{GEN} =3 Ω, V _{GS} =-4.5V)	t _f	—	21.2	—	ns

■ Dimension 外形封装尺寸



SYMBOL	MILLIMETERS		
	MIN	TYP	MAX
A	0.68	0.80	0.92
A1	0.00	0.05	0.15
A2	0.68	0.75	0.82
b1	0.20	0.25	0.30
b2	0.30	0.35	0.40
c	0.10	0.15	0.20
D	1.48	0.16	1.72
E	0.68	0.80	0.92
E1	1.42	1.50	1.77
e	0.50TYP		
e1	0.90	1.00	1.10
L	0.40REF		
L1	0.15	0.25	0.35
o	0°	4°	8°